FQU12N20TU Datasheet

https://www.DiGi-Electronics.com

DiGi Electronics Part Number	FQU12N20TU-DG
Manufacturer	onsemi
Manufacturer Product Number	FQU12N20TU
Description	MOSFET N-CH 200V 9A IPAK
Detailed Description	N-Channel 200 V 9A (Tc) 2.5W (Ta), 55W (Tc) Through Hole IPAK

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
FQU12N20TU	onsemi
Series:	Product Status:
QFET®	Obsolete
FET Type:	Technology:
N-Channel	MOSFET (Metal Oxide)
Drain to Source Voltage (Vdss):	Current - Continuous Drain (Id) @ 25°C:
200 V	9A (Tc)
Drive Voltage (Max Rds On, Min Rds On):	Rds On (Max) @ Id, Vgs:
10V	280mOhm @ 4.5A, 10V
Vgs(th) (Max) @ Id:	Gate Charge (Qg) (Max) @ Vgs:
5V @ 250μA	23 nC @ 10 V
Vgs (Max):	Input Capacitance (Ciss) (Max) @ Vds:
±30V	910 pF @ 25 V
FET Feature:	Power Dissipation (Max):
-	2.5W (Ta), 55W (Tc)
Operating Temperature:	Mounting Type:
-55°C ~ 150°C (TJ)	Through Hole
Supplier Device Package:	Package / Case:
IPAK	TO-251-3 Short Leads, IPak, TO-251AA
Base Product Number:	
FQU12N20	

Environmental & Export classification

RoHS Status:	Moisture Sensitivity Level (MSL):
ROHS3 Compliant	Not Applicable
REACH Status:	ECCN:
REACH Unaffected	EAR99
HTSUS:	
8541.29.0095	

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FAIRCHILD SEMICONDUCTOR®

October 2013

FQD12N20 / FQU12N20

N-Channel QFET® MOSFET

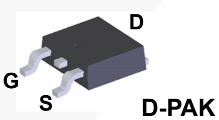
200 V, 9 A, 280 mΩ

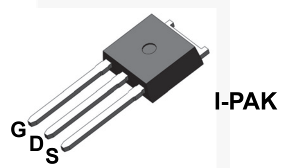
Description

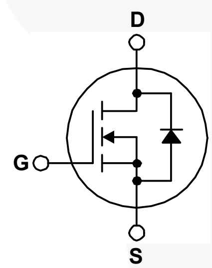
This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, active power factor correction (PFC), and electronic lamp ballasts.

Features

- 9 A, 200 V, $R_{DS(on)}$ = 280 mΩ (Max.) @ V_{GS} = 10 V, I_D = 4.5 A
- Low Gate Charge (Typ. 18 nC)
- Low Crss (Typ. 18 pF)
- 100% Avalanche Tested
- RoHS Compliant







Absolute Maximum Ratings T_C = 25°C unless otherwise noted.

Symbol	Parameter		FQD12N20TM / FQU12N20TU	Unit
V_{DSS}	Drain-Source Voltage		200	V
I_D	Drain Current - Continuous (T_C = 25°C)		9.0	A
	- Continuous (T_C = 100°C)		5.7	A
I_{DM}	Drain Current - Pulsed	(Note 1)	36	A
V_{GSS}	Gate-Source Voltage		± 30	V
E_{AS}	Single Pulsed Avalanche Energy	(Note 2)	210	mJ
I_{AR}	Avalanche Current	(Note 1)	9.0	A
E_{AR}	Repetitive Avalanche Energy	(Note 1)	5.5	mJ
dv/dt	Peak Diode Recovery dv/dt	(Note 3)	5.5	V/ns
P_D	Power Dissipation (T_A = 25°C) *		2.5	W
	Power Dissipation (T_C = 25°C)		55	W
	- Derate above 25°C		0.44	W/°C
T_J, T_{STG}	Operating and Storage Temperature Range		-55 to +150	°C
T_L	Maximum lead temperature for soldering purposes, 1/8" from case for 5 seconds		300	°C

Thermal Characteristics

Symbol	Parameter	FQD12N20TM FQU12N20TU	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case, Max.	2.27	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient (minimum pad of 2 oz copper), Max.	110	
	Thermal Resistance, Junction to Ambient (*1 in^2 pad of 2 oz copper), Max.	50	

Package Marking and Ordering Information

Part Number	Top Mark	Package	Packing Method	Reel Size	Tape Width	Quantity
FQD12N20TM	FQD12N20	D-PAK	Tape and Reel	330 mm	16 mm	2500 units
FQU12N20TU	FQU12N20	I-PAK	Tube	N/A	N/A	70 units

Electrical Characteristics T_C = 25°C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min	Typ	Max	Unit
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS} = 0 V, I_D = 250 µA	200	--	--	V
ΔBV_{DSS} / ΔT_J	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C	--	0.14	--	V/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 200 V, V_{GS} = 0 V	--	--	1	µA
		V_{DS} = 160 V, T_C = 125°C	--	--	10	µA
I_{GSSF}	Gate-Body Leakage Current, Forward	V_{GS} = 30 V, V_{DS} = 0 V	--	--	100	nA
I_{GSSR}	Gate-Body Leakage Current, Reverse	V_{GS} = -30 V, V_{DS} = 0 V	--	--	-100	nA
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS} = V_{GS}, I_D = 250 µA	3.0	--	5.0	V
$R_{DS(on)}$	Static Drain-Source On-Resistance	V_{GS} = 10 V, I_D = 4.5 A	--	0.21	0.28	Ω
g_{FS}	Forward Transconductance	V_{DS} = 40 V, I_D = 4.5 A	--	7.3	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{DS} = 25 V, V_{GS} = 0 V, f = 1.0 MHz	--	700	910	pF
C_{oss}	Output Capacitance		--	125	160	pF
C_{rss}	Reverse Transfer Capacitance		--	18	25	pF
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	V_{DD} = 100 V, I_D = 11.6 A, R_G = 25 Ω (Note 4)	--	13	35	ns
t_r	Turn-On Rise Time		--	120	250	ns
$t_{d(off)}$	Turn-Off Delay Time		--	30	70	ns
t_f	Turn-Off Fall Time		--	55	120	ns
Q_g	Total Gate Charge	V_{DS} = 160 V, I_D = 11.6 A, V_{GS} = 10 V (Note 4)	--	18	23	nC
Q_{gs}	Gate-Source Charge		--	5	--	nC
Q_{gd}	Gate-Drain Charge		--	8	--	nC
Drain-Source Diode Characteristics and Maximum Ratings						
I_S	Maximum Continuous Drain-Source Diode Forward Current		--	--	9.0	A
I_{SM}	Maximum Pulsed Drain-Source Diode Forward Current		--	--	36	A
V_{SD}	Drain-Source Diode Forward Voltage	V_{GS} = 0 V, I_S = 9.0 A	--	--	1.5	V
t_{rr}	Reverse Recovery Time	V_{GS} = 0 V, I_S = 11.6 A, dI_F / dt = 100 A/µs	--	130	--	ns
Q_{rr}	Reverse Recovery Charge		--	0.63	--	µC

Notes:
1. Repetitive Rating : Pulse width limited by maximum junction temperature
2. L = 3.9 mH, I_{AS} = 9.0 A, V_{DD} = 50 V, R_G = 25 Ω, Starting T_J = 25°C
3. I_{SD} ≤ 11.6 A, di/dt ≤ 300 A/µs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C
4. Essentially independent of operating temperature

Typical Characteristics

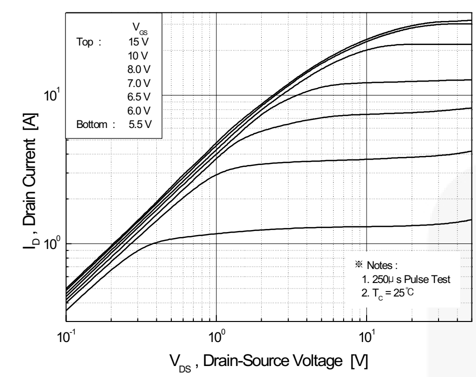


Figure 1. On-Region Characteristics

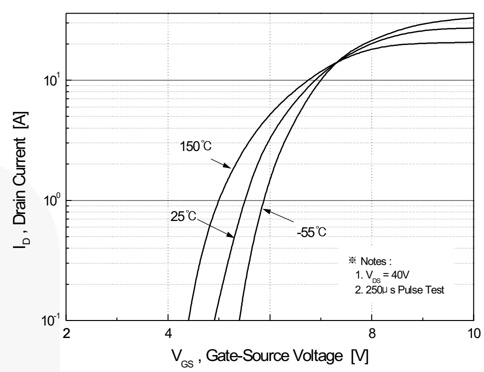


Figure 2. Transfer Characteristics

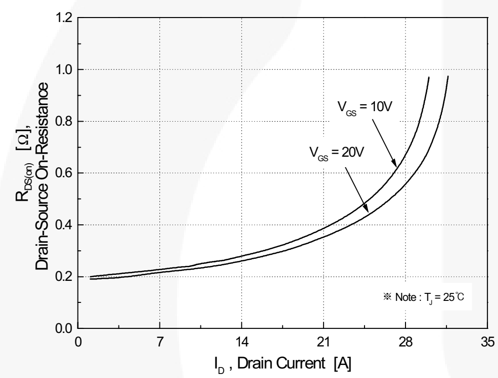


Figure 3. On-Resistance Variation vs. Drain Current and Gate Voltage

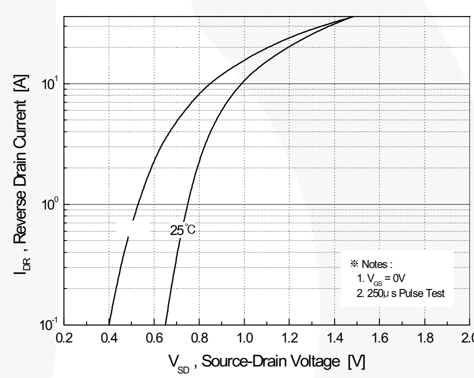


Figure 4. Body Diode Forward Voltage Variation vs. Source Current and Temperature

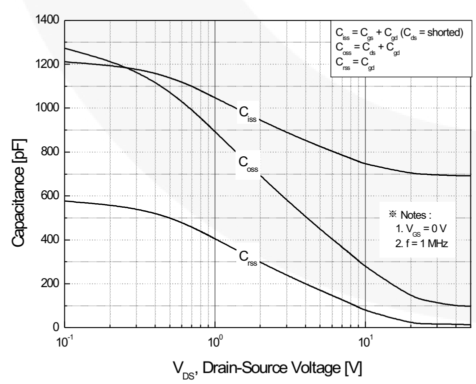


Figure 5. Capacitance Characteristics

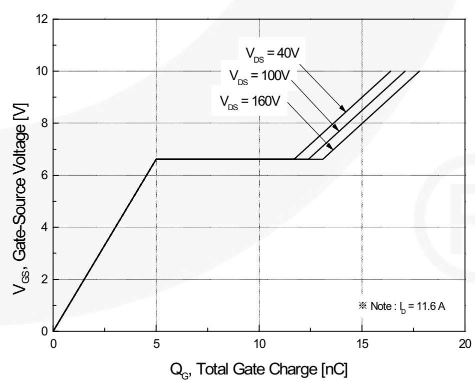


Figure 6. Gate Charge Characteristics

Typical Characteristics (Continued)

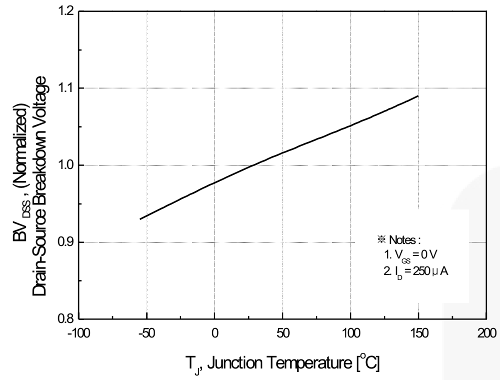


Figure 7. Breakdown Voltage Variation vs. Temperature

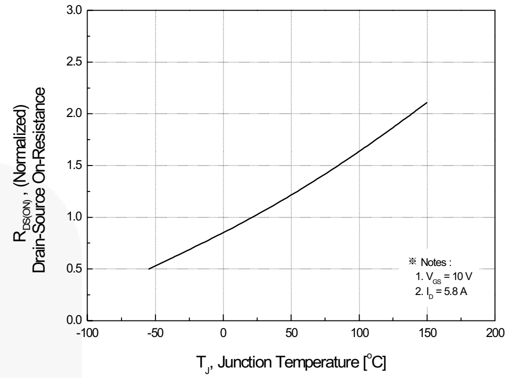


Figure 8. On-Resistance Variation vs. Temperature

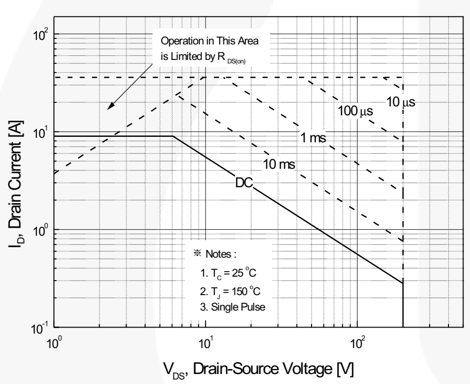


Figure 9. Maximum Safe Operating Area

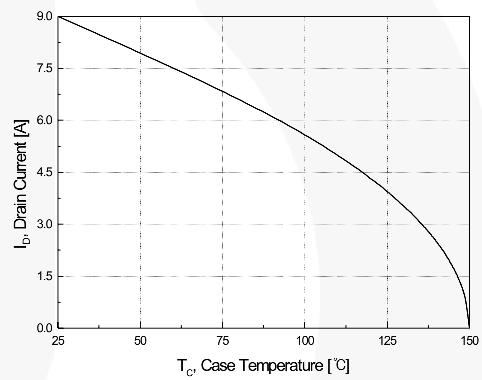


Figure 10. Maximum Drain Current vs. Case Temperature

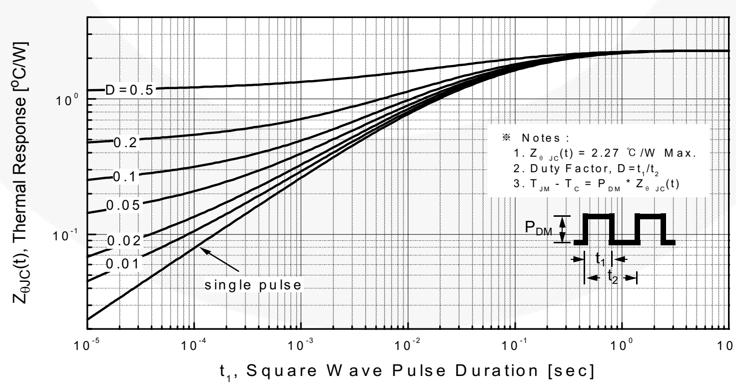


Figure 11. Transient Thermal Response Curve

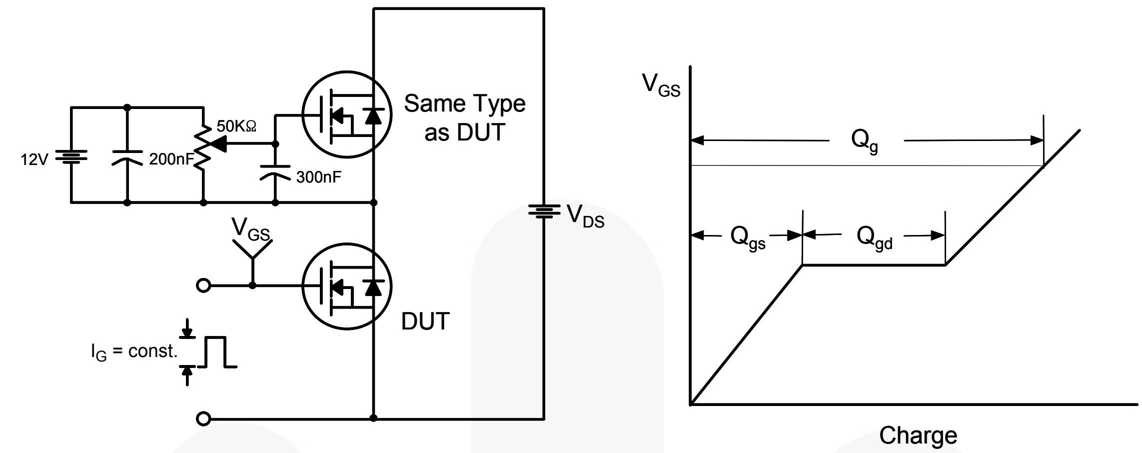


Figure 12. Gate Charge Test Circuit & Waveform

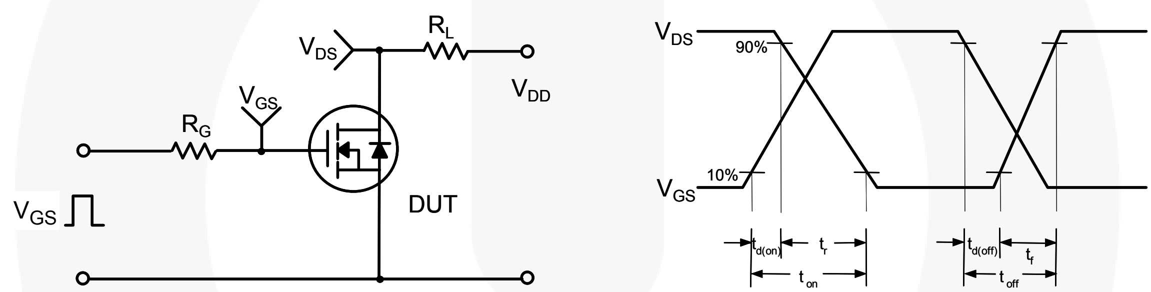


Figure 13. Resistive Switching Test Circuit & Waveforms

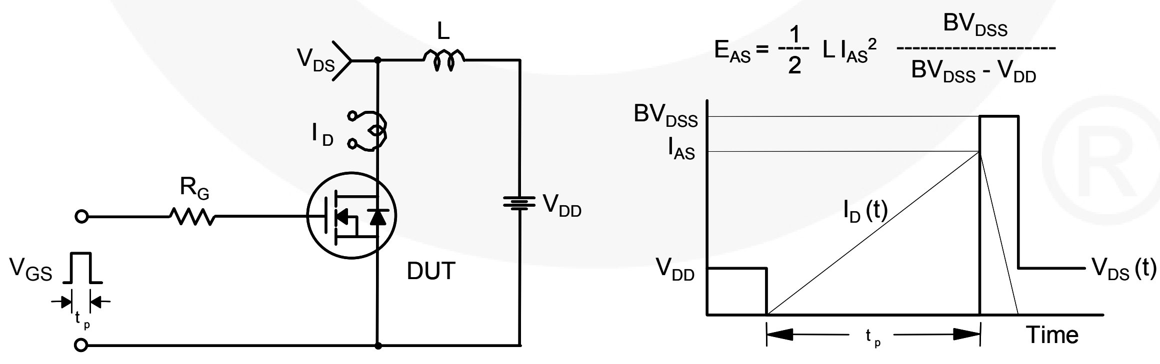


Figure 14. Unclamped Inductive Switching Test Circuit & Waveforms

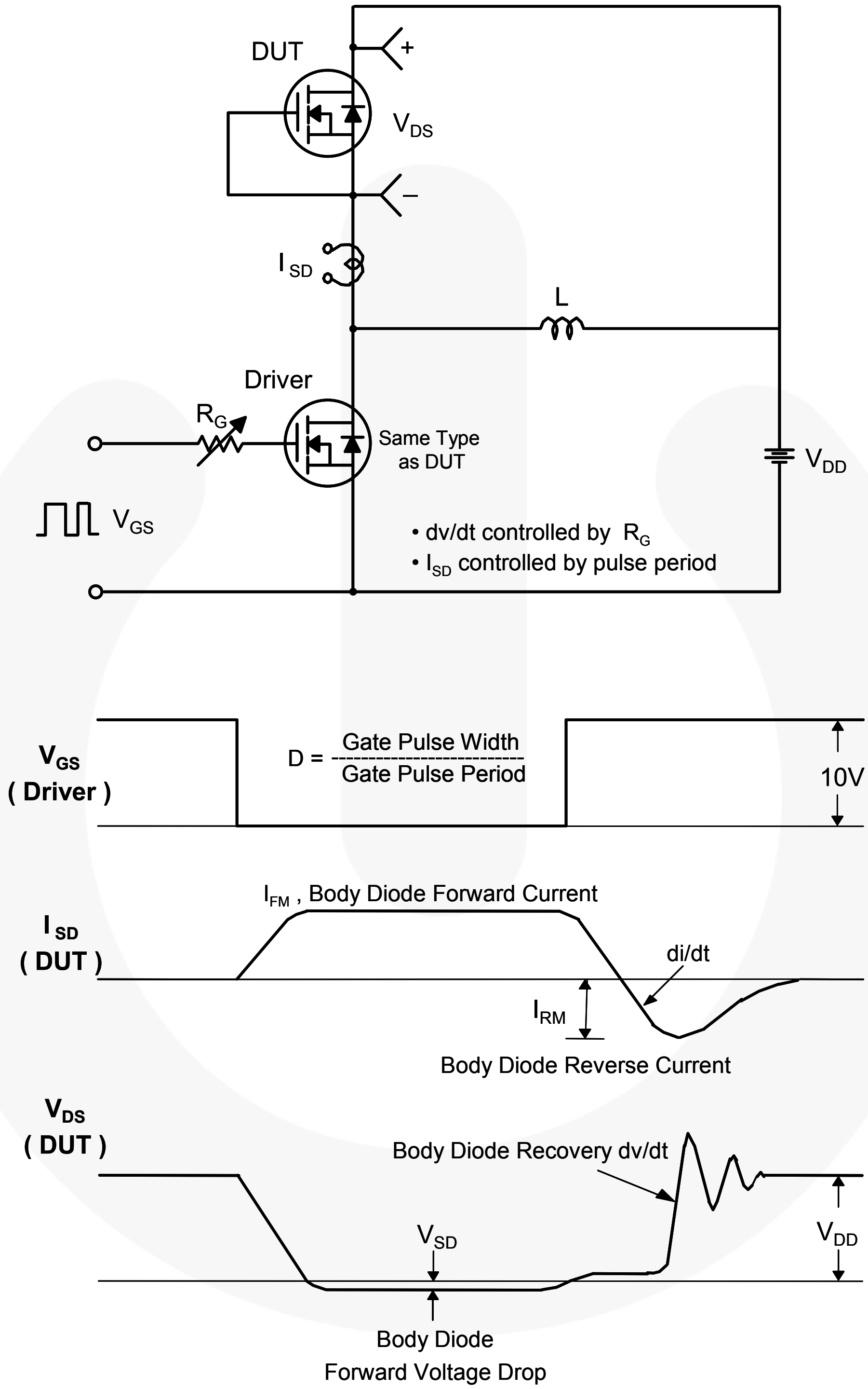


Figure 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

Mechanical Dimensions

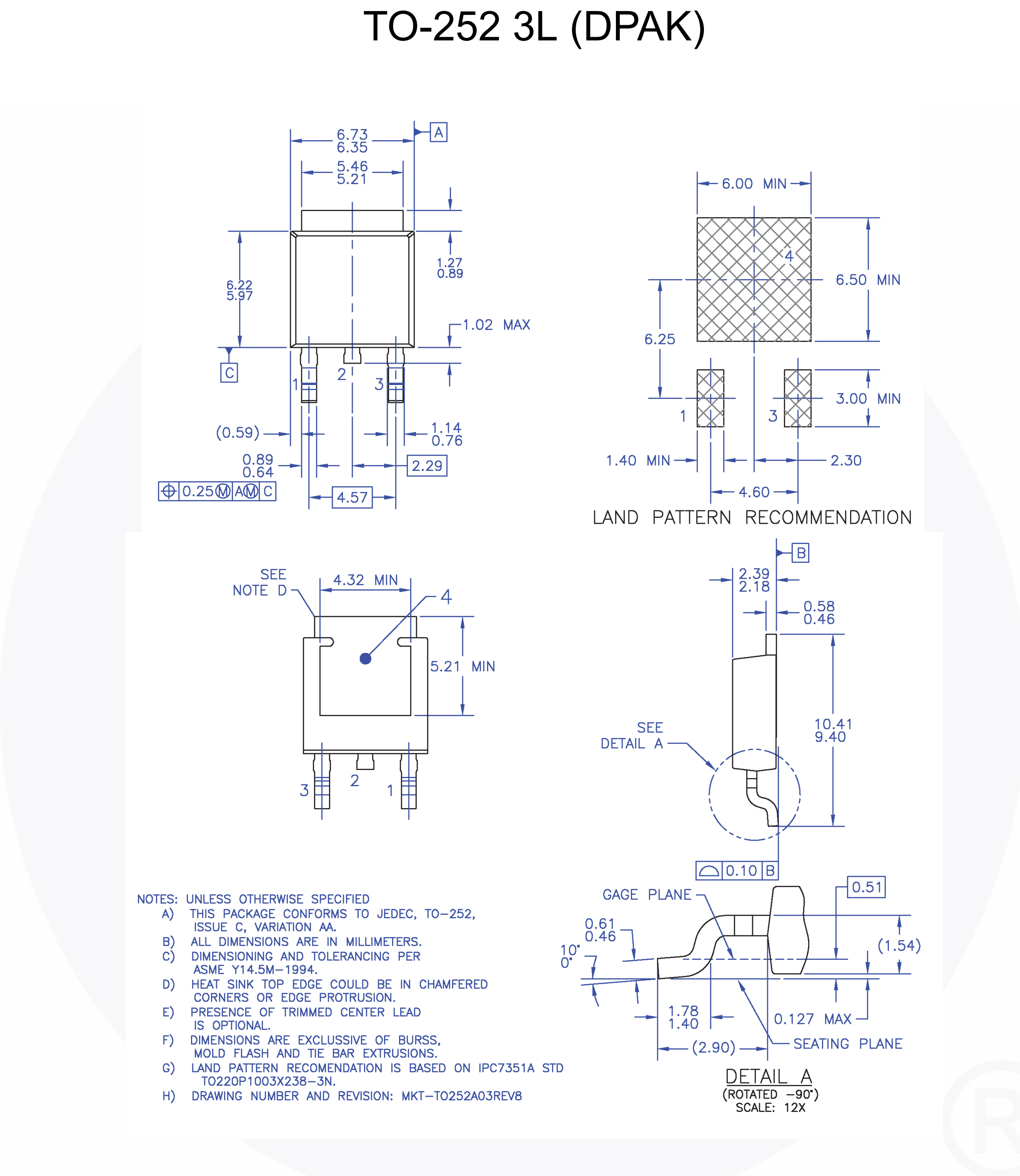


Figure 16. TO252 (D-PAK), Molded, 3 Lead, Option AA&AB

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Dimension in Millimeters

Mechanical Dimensions

TO-251 3L (IPAK)

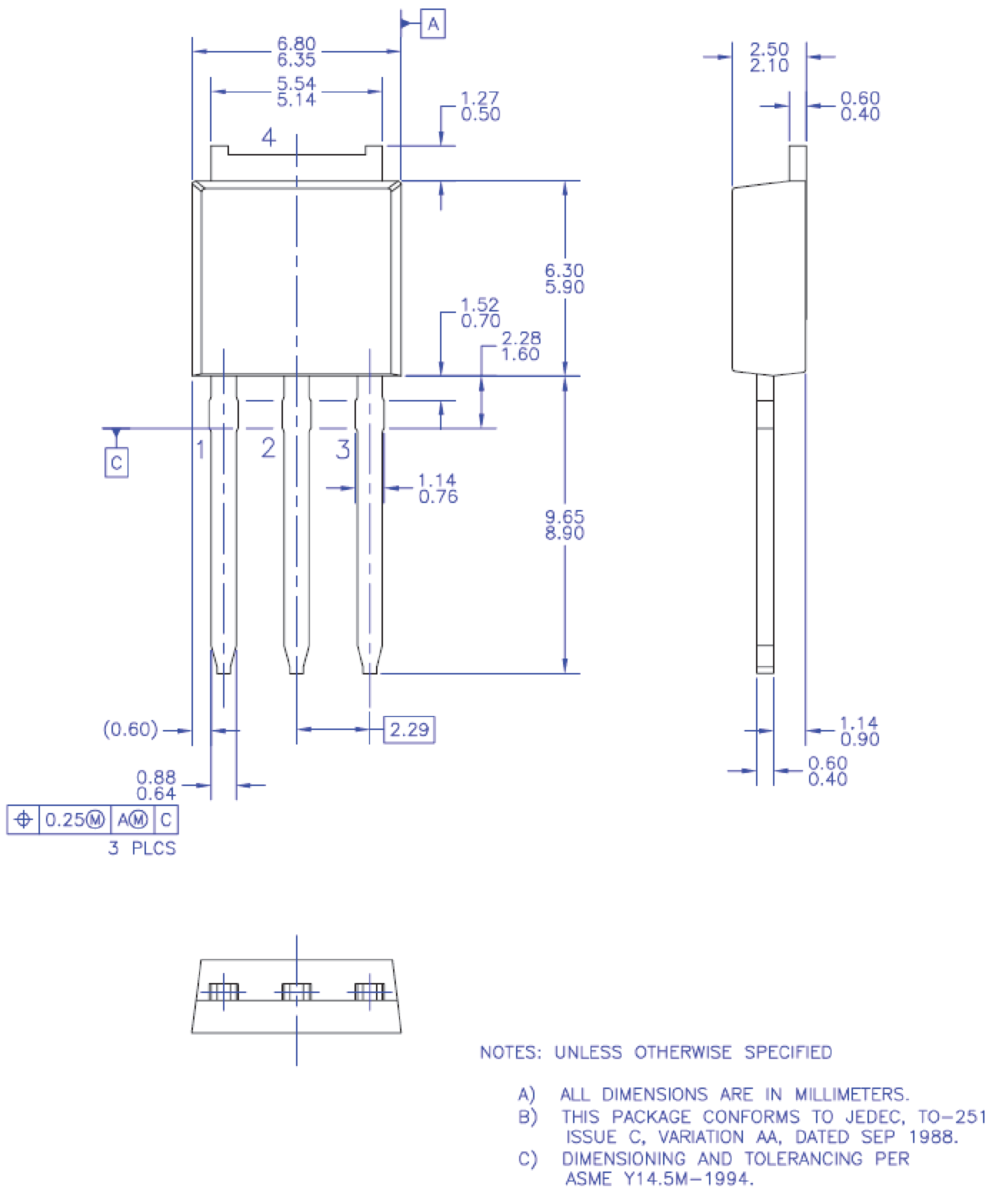

Figure 17. TO251 (IPAK) Molded 3 Lead

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Dimension in Millimeters

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